



# 2SC6097

## Bipolar Transistor 60V, 3A, Low VCE(sat), NPN Single TP/TP-FA

ON Semiconductor®

<http://onsemi.com>

### Applications

- DC / DC converter, relay drivers, lamp drivers, motor drivers, inverter

### Features

- Adoption of FBET, MBIT process
- Low collector-to-emitter saturation voltage
- High allowable power dissipation
- Large current capacity
- High-speed switching

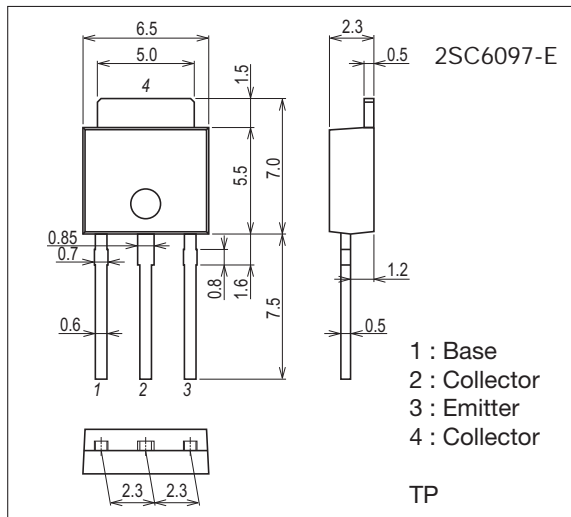
### Specifications

Absolute Maximum Ratings at Ta=25°C

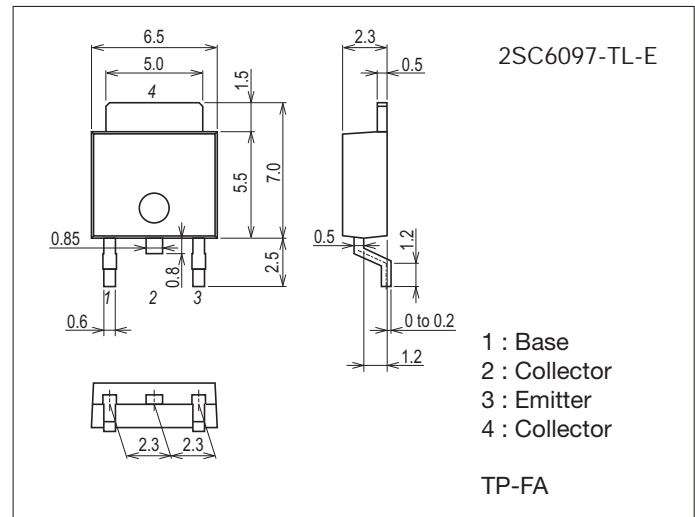
Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	V <sub>CB0</sub>		100	V
Collector-to-Emitter Voltage	V <sub>CES</sub>		100	V
Collector-to-Emitter Voltage	V <sub>CEO</sub>		60	V
Emitter-to-Base Voltage	V <sub>EB0</sub>		6.5	V
Collector Current	I <sub>C</sub>		3	A
Collector Current (Pulse)	I <sub>CP</sub>		5	A
Base Current	I <sub>B</sub>		600	mA

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### Package Dimensions unit : mm (typ) 7518-003



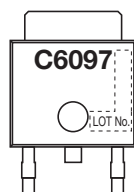
### Package Dimensions unit : mm (typ) 7003-003



### Product & Package Information

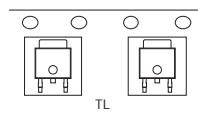
- Package : TP
- JEITA, JEDEC : SC-64, TO-251
- Minimum Packing Quantity : 500 pcs./bag

### Marking (TP, TP-FA)

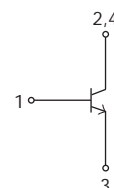


- Package : TP-FA
- JEITA, JEDEC : SC-63, TO-252
- Minimum Packing Quantity : 700 pcs./reel

### Packing Type (TP-FA) : TL



### Electrical Connection



## 2SC6097

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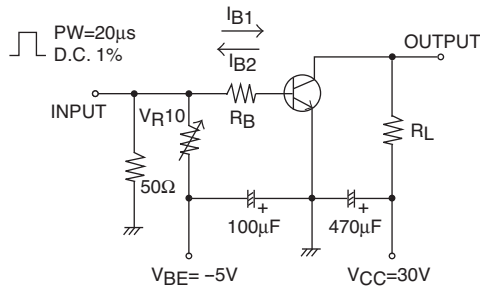
Parameter	Symbol	Conditions	Ratings	Unit
Collector Dissipation	PC		0.8	W
		T <sub>c</sub> =25°C	15	W
Junction Temperature	T <sub>j</sub>		150	°C
Storage Temperature	T <sub>stg</sub>		-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### Electrical Characteristics at T<sub>a</sub>=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	I <sub>CBO</sub>	V <sub>CB</sub> =50V, I <sub>E</sub> =0A			1	μA
Emitter Cutoff Current	I <sub>EBO</sub>	V <sub>EB</sub> =4V, I <sub>C</sub> =0A			1	μA
DC Current Gain	h <sub>FE</sub>	V <sub>CE</sub> =2V, I <sub>C</sub> =100mA	300		600	
Gain-Bandwidth Product	f <sub>T</sub>	V <sub>CE</sub> =10V, I <sub>C</sub> =500mA		390		MHz
Output Capacitance	C <sub>ob</sub>	V <sub>CB</sub> =10V, f=1MHz		18		pF
Collector-to-Emitter Saturation Voltage	V <sub>CE(sat)1</sub>	I <sub>C</sub> =1A, I <sub>B</sub> =50mA		100	150	mV
	V <sub>CE(sat)2</sub>	I <sub>C</sub> =1A, I <sub>B</sub> =100mA		90	135	mV
Base-to-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	I <sub>C</sub> =1A, I <sub>B</sub> =100mA		0.84	1.2	V
Collector-to-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> =10μA, I <sub>E</sub> =0A	100			V
Collector-to-Emitter Breakdown Voltage	V <sub>(BR)CES</sub>	I <sub>C</sub> =100μA, R <sub>BE</sub> =0Ω	100			V
Collector-to-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> =1mA, R <sub>BE</sub> =∞	60			V
Emitter-to-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> =10μA, I <sub>C</sub> =0A	6.5			V
Turn-On Time	t <sub>on</sub>	See specified Test Circuit		35		ns
Storage Time	t <sub>stg</sub>			680		ns
Fall Time	t <sub>f</sub>			24		ns

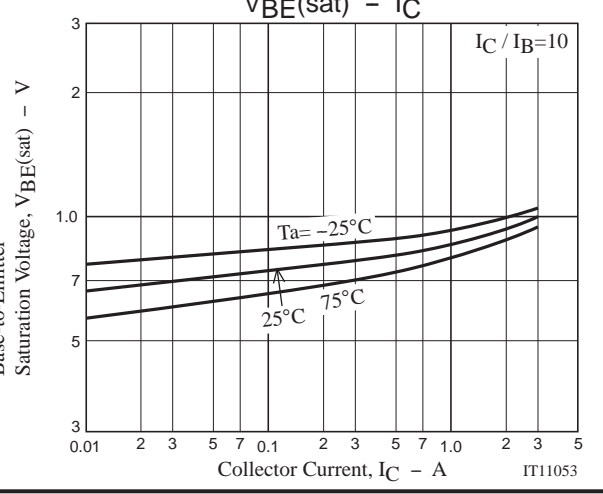
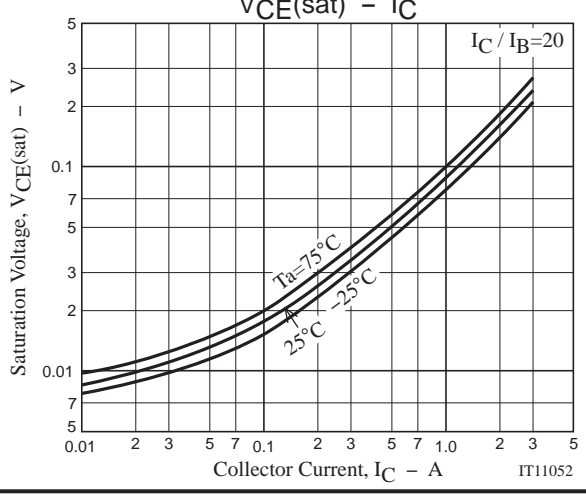
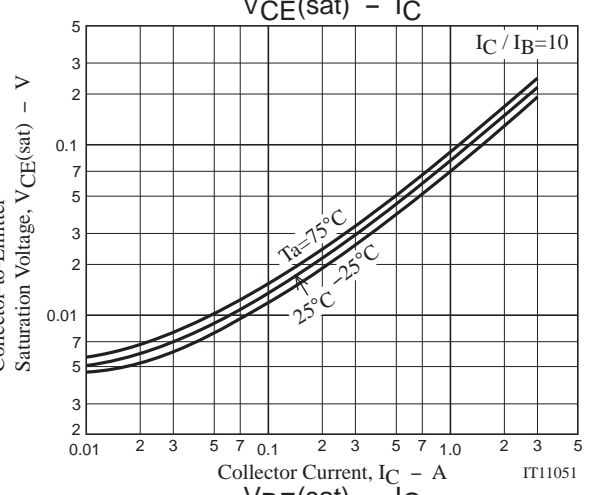
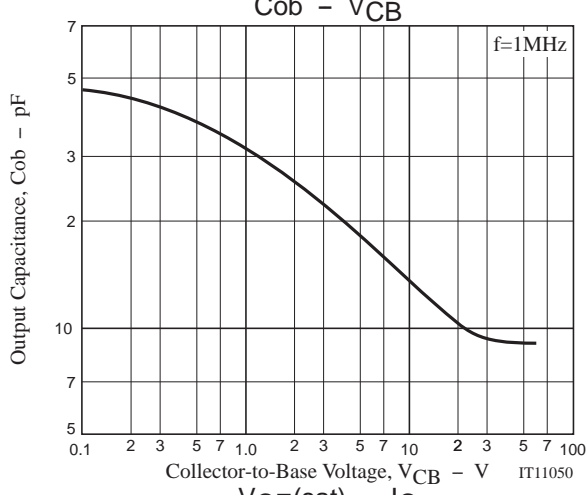
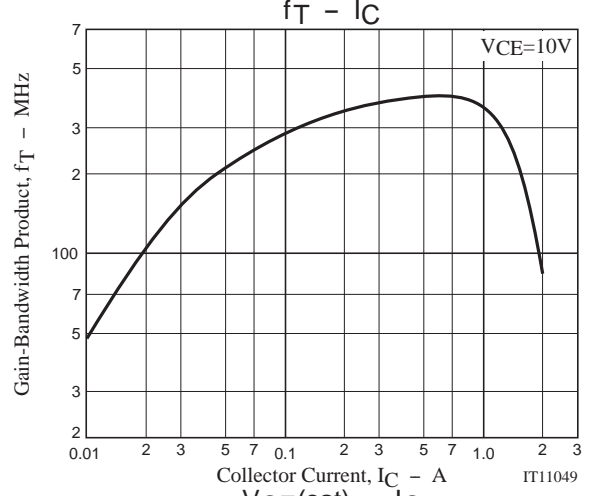
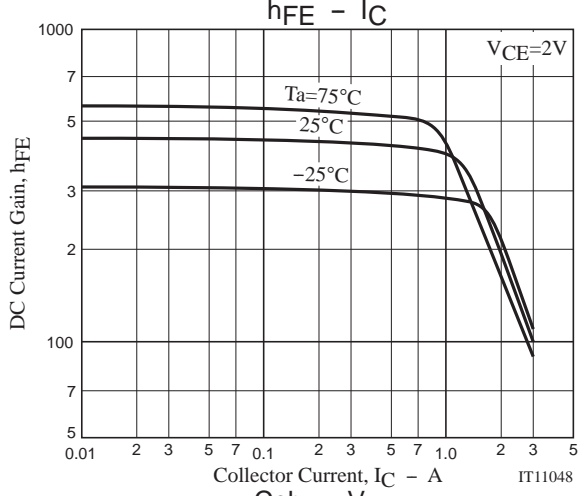
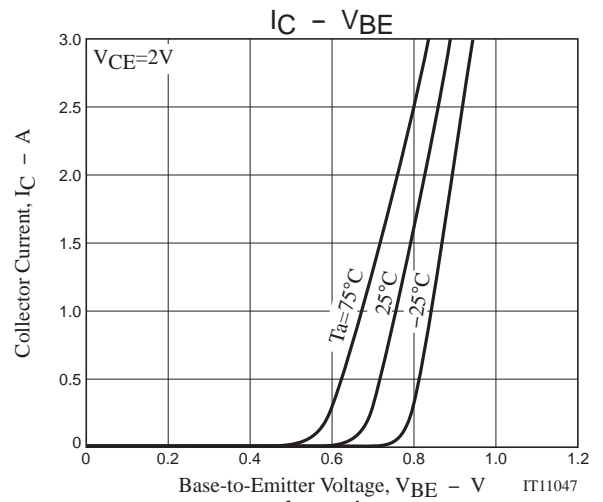
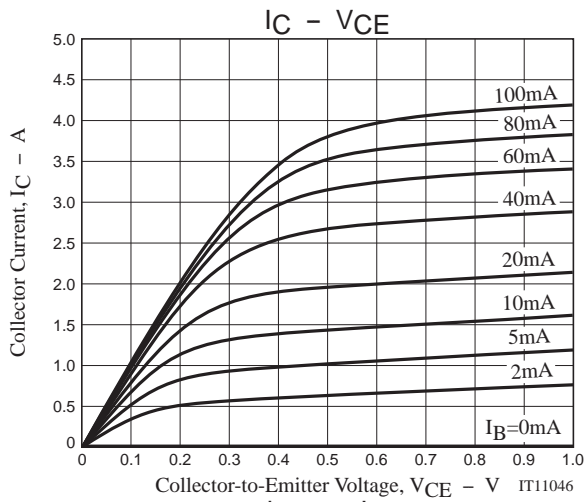
### Switching Time Test Circuit

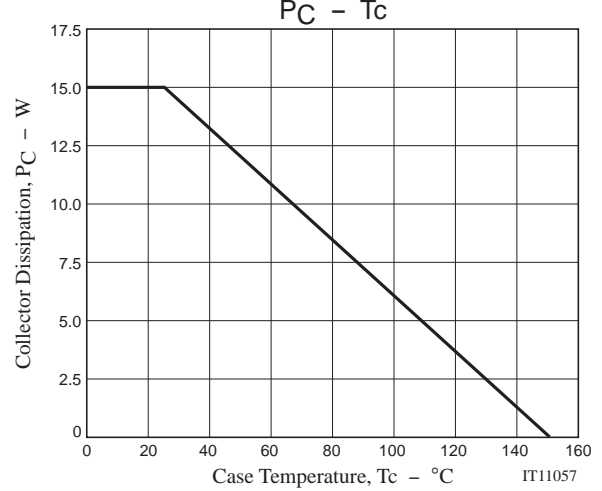
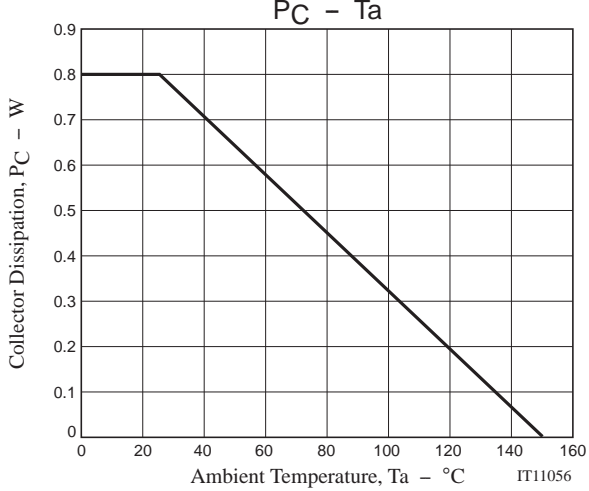
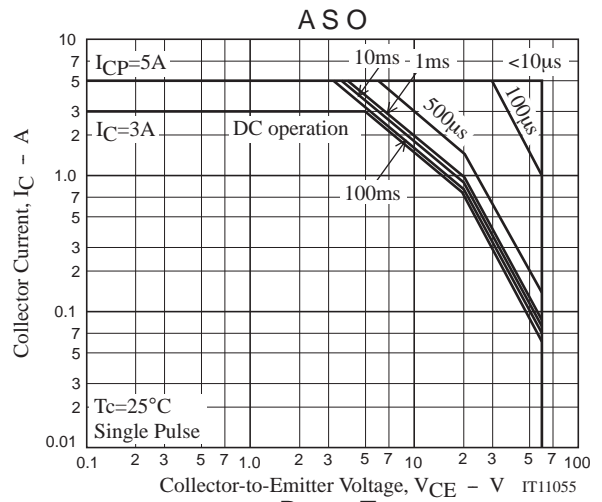
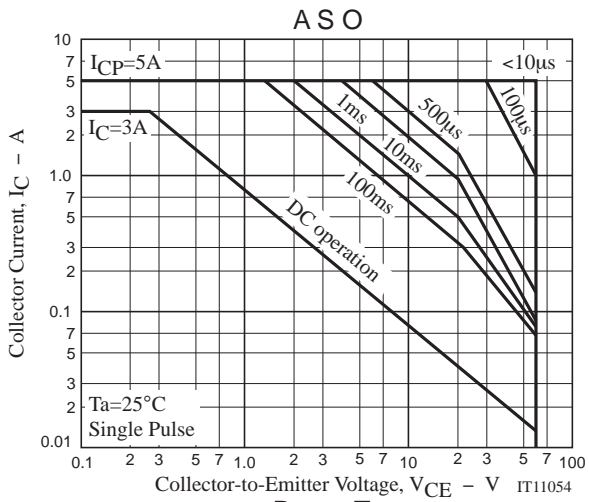


$$I_C = 10I_{B1} = -10I_{B2} = 0.5A$$

### Ordering Information

Device	Package	Shipping	memo
2SC6097-E	TP	500pcs./bag	Pb Free
2SC6097-TL-E	TP-FA	700pcs./reel	Pb Free





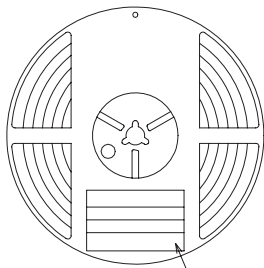
Taping Specification

2SC6097-TL-E

Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
TP-FA	TP	700	2,100	12,600	3 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

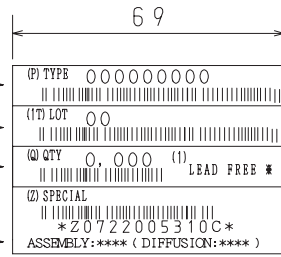
Packing method



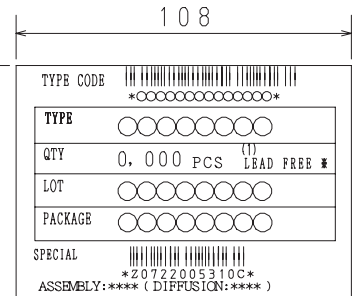
Reel label

Type No.  
LOT No.  
Quantity  
Origin

Reel label, Inner box label (unit:mm)



Outer box label  
It is a label at the time of factory shipments. The form of a label may change in physical distribution process.



NOTE (1)

The LEAD FREE \* description shows that the surface treatment of the terminal is lead free.

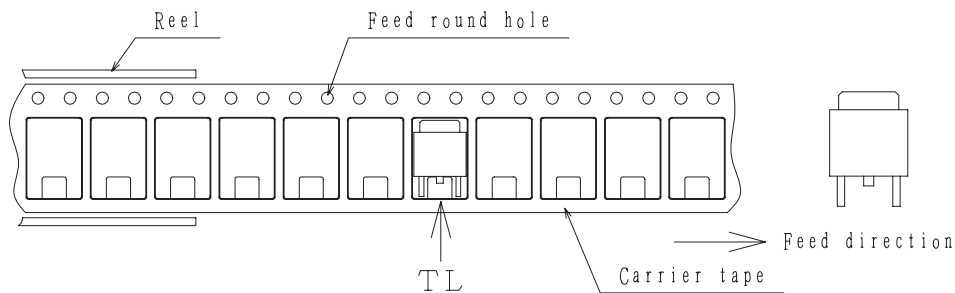
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

Taping configuration

1. Carrier tape size (unit:mm)



2. Device placement direction

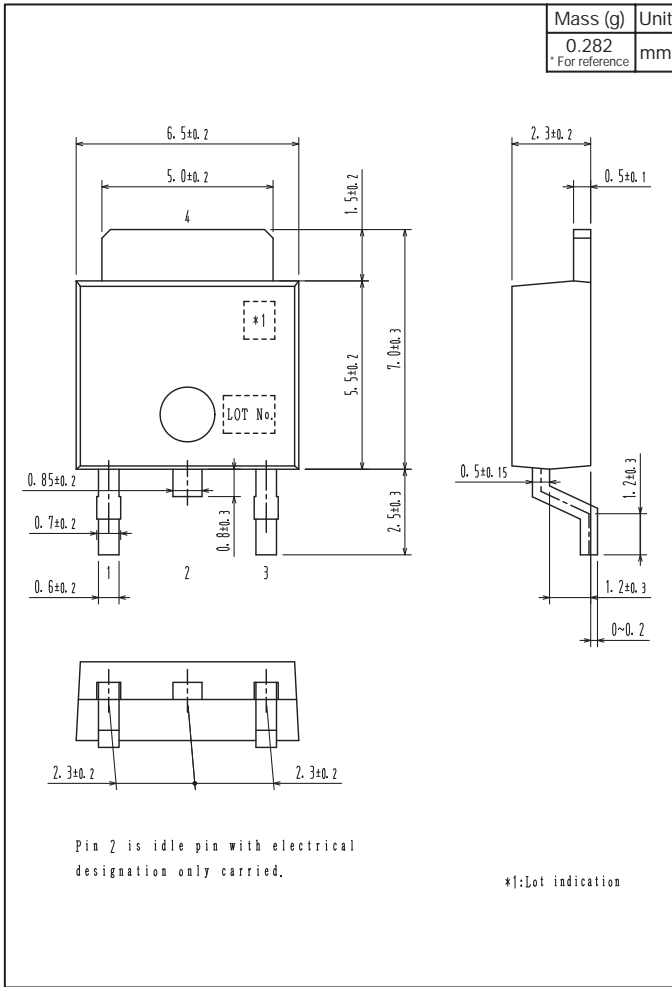


Those with one electrode terminal on the feed hole side.....TL

Outline Drawing

2SC6097-TL-E

Land Pattern Example



Bag Packing Specification

2SC6097-E

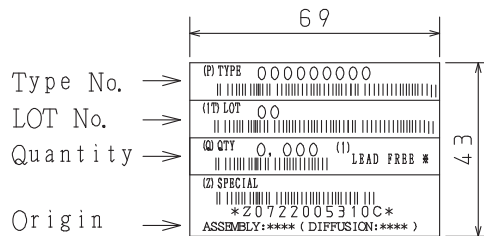
1. Packing Format

Package Name	Maximum Number of devices contained (pcs)			
	Bag	Inner box	Outer box	
TP	500	B-1	A-1	A-2
		10,000	50,000	30,000
	Packing format (Dimensions:mm (external))			
		Inner box	Outer box	
		B-1	A-1	A-2
		445×225×55	470×250×300	470×250×190

2. Bag dimensions  
(unit:mm)



3. Bag label, Inner box label  
(unit:mm)



4. Outer box label  
(unit:mm)

It is a label at the time of factory shipments.  
The form of a label may change in physical distribution process.

NOTE (1)

The LEAD FREE \* description shows that the surface treatment of the terminal is lead free.

Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3



Outline Drawing

2SC6097-E





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